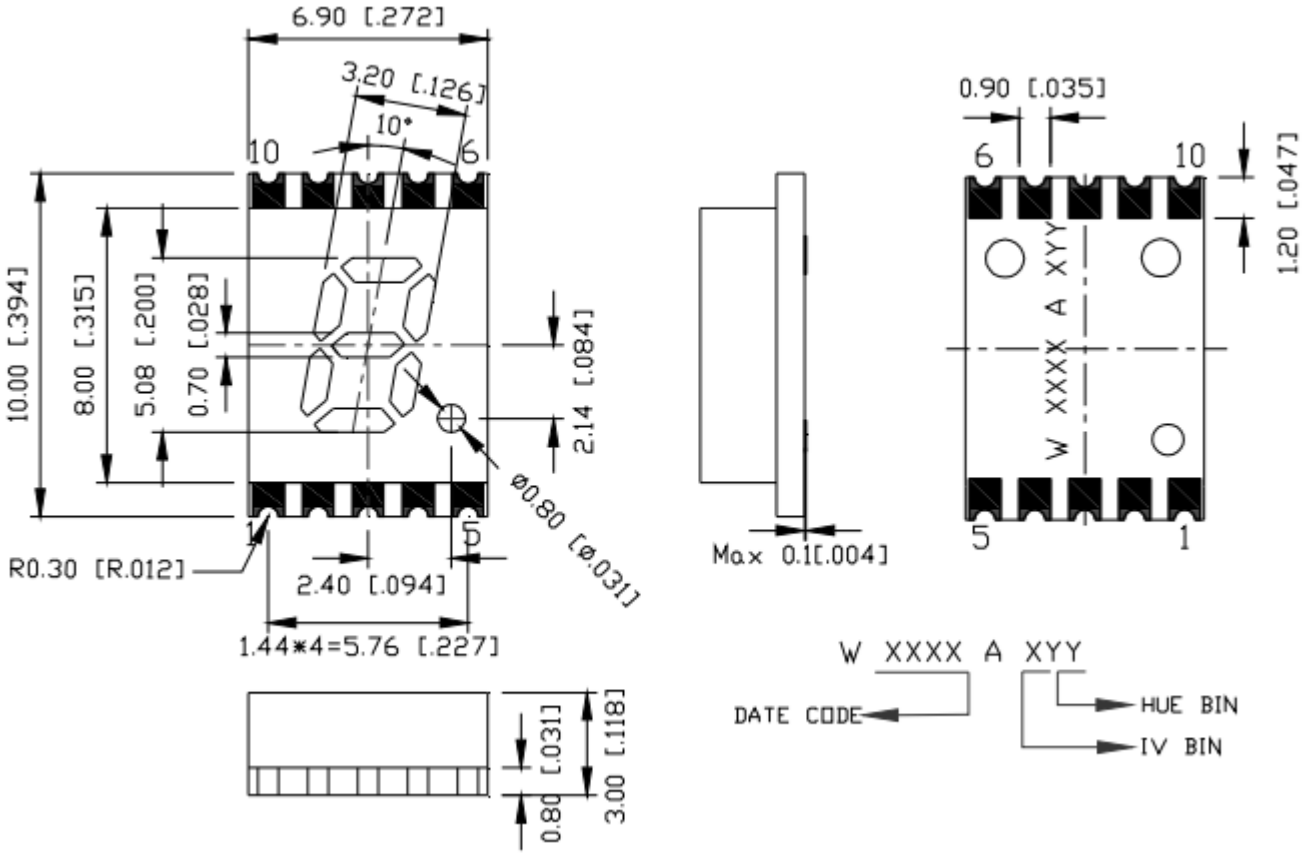
American Opto Plus LED Corp.
SMC201W G/W
0.2” White Single Digit SMD Display

MECHANICAL DIMENSIONS

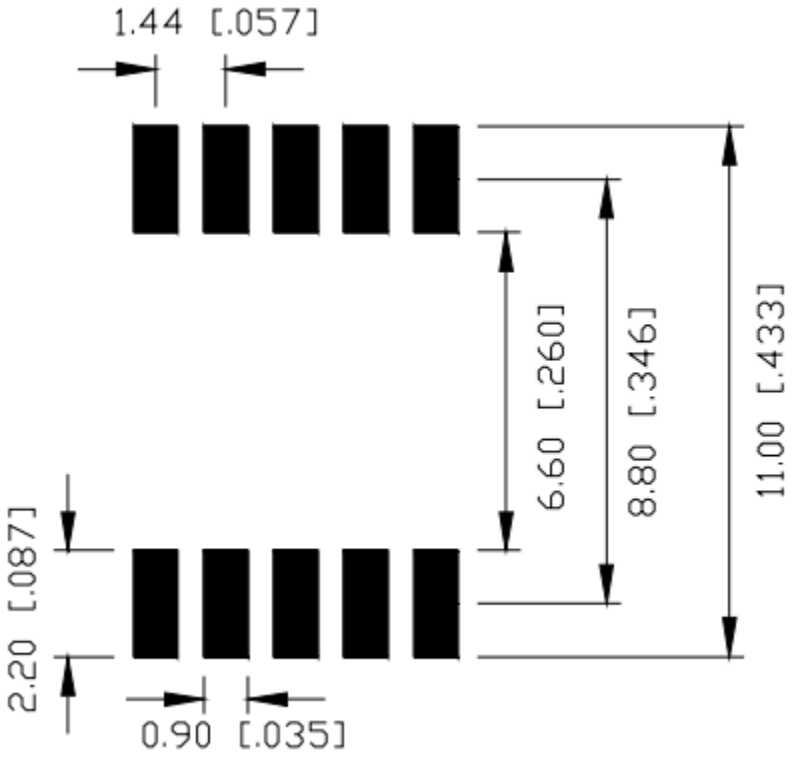


Notes:

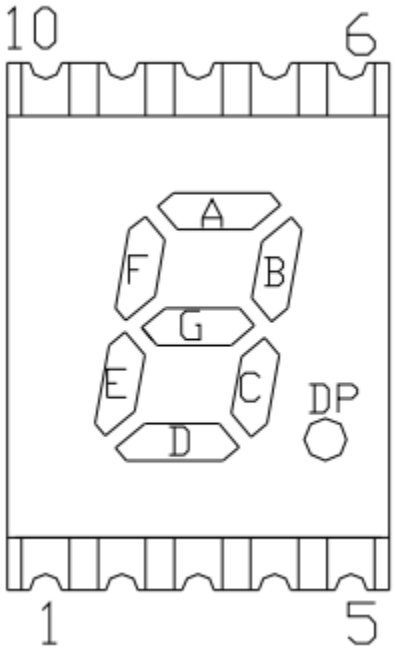
1. Dimension in millimeter [inch], tolerance is ±0.25 [0.10] unless otherwise noted.
2. All pins are Φ0.6 ±0.1

Chip Material	Emitted Color	Segment/Face	Description
InGaN	White	White/Gray	Common Cathode

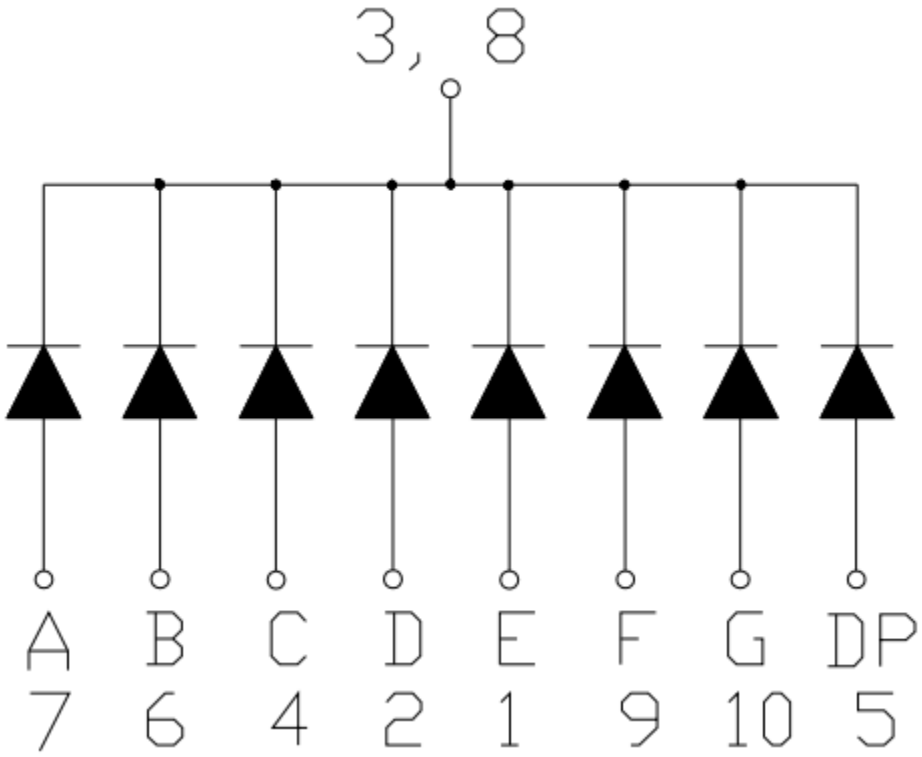
RECOMMENDED SOLDERING PAD SIZE



ALL LIGHT ON SEGMENTS FEATURE AND PAD POSITION



INTERNAL CIRCUIT DIAGRAMS



ABSOLUTE MAXIMUM RATING **(Ta=25°C)**

Parameter	Symbol	Rating	Unit
Power Dissipation (Per Dice)	P_D	114	mW
Continuous Forward Current (Per Dice)	I_F	30	mA
Peak Current (Per Dice, duty cycle 1/10,1KHz)	I_{FP}	100	mA
Derating Liner from 25°C(Per Dice)	$\Delta I_F/\Delta T$	0.4	mA/°C
Reverse Voltage (Per Dice)	V_R	5	V
Electrostatic discharge(HBM)	ESD	1000	V
Operating Temp.	T_{OPR}	-40 ~ +105	°C
Storage Temp.	T_{STG}	-40 ~ +105	°C
Hand Soldering Temp.	T_{SOL}	350	°C

ELECTRO-OPTICAL CHARACTERISTICS **(Ta=25°C)**

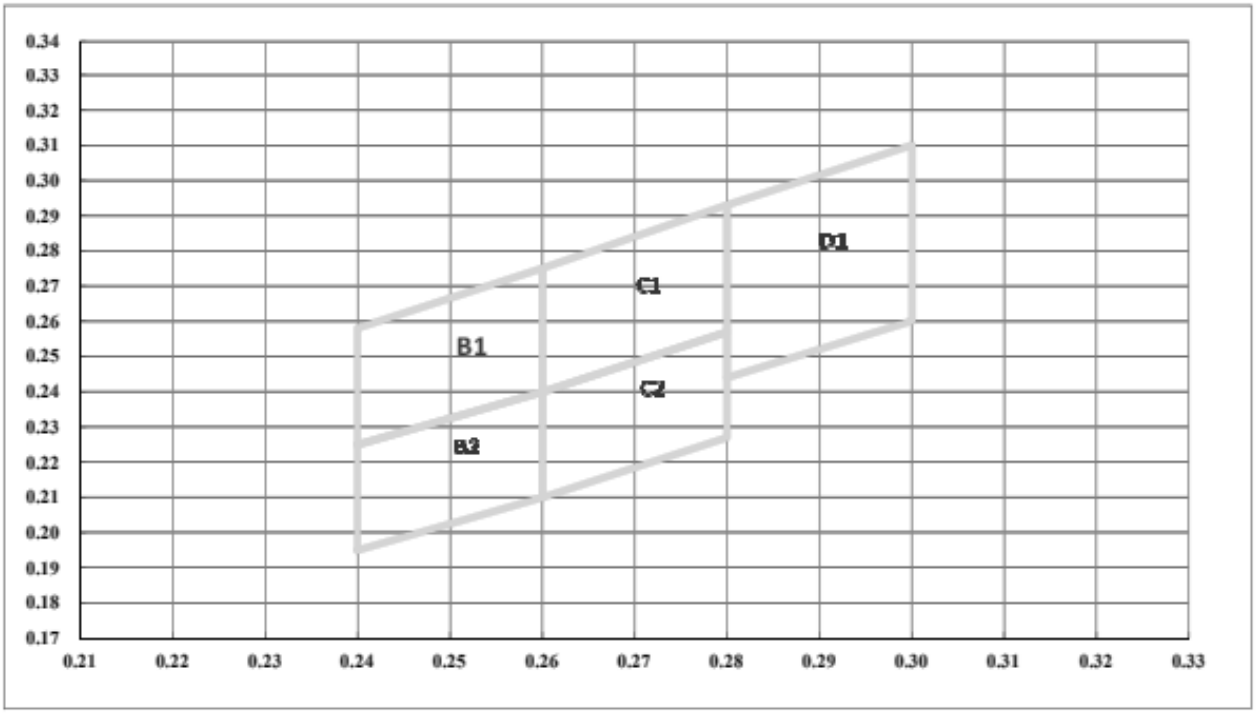
Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage (Per Segment)	V_F	IF=5mA	--	2.5	3.1	V
Chromaticity Coordinates	X		--	0.27	--	--
	Y		--	0.25	--	--
Luminous Intensity (Per Segment)	I_V		--	50	--	mcd
Luminous Intensity Matching Ratio	I_V-m		--	--	2:1	--
Reverse Current	I_r	VR=5V	--	--	50	μA

LUMINOUS INTENSITY CLASSIFICATION **(IF=5mA)**

Bin Code	Min	Max	Unit
M	27.559	44.095	mcd
N	44.096	70.554	
P	70.555	112.888	

Notes:
1. Remark: Unit=mcd
2. Tolerance: ±20%

COLOR RANK LIMIT **(IF=5mA)**



B1					B2				
X	0.240	0.240	0.260	0.260	X	0.240	0.240	0.260	0.260
Y	0.225	0.258	0.275	0.240	Y	0.195	0.225	0.240	0.210
C1					**C2**				
X	0.260	0.260	0.280	0.280	X	0.260	0.260	0.280	0.280
Y	0.240	0.275	0.293	0.257	Y	0.210	0.240	0.257	0.227
D1									
X	0.280	0.280	0.300	0.300					
Y	0.244	0.293	0.310	0.260					

ELECTRICAL/OPTICAL CHARACTERISTICS CURVES

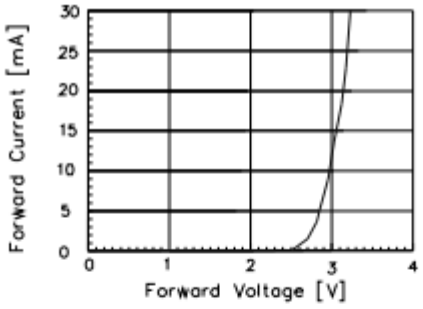


Fig 1. Forward Current vs. Forward Voltage

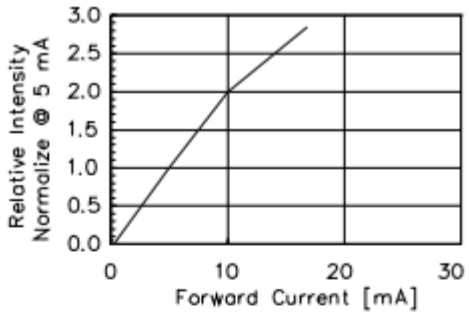


Fig 2. Relative Intensity vs. Forward Current

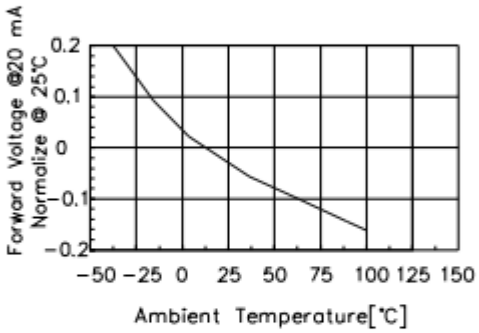


Fig 3. Forward Voltage vs. Temperature

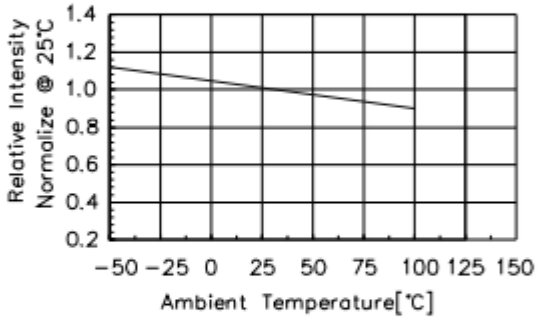


Fig 4. Relative Intensity vs. Temperature

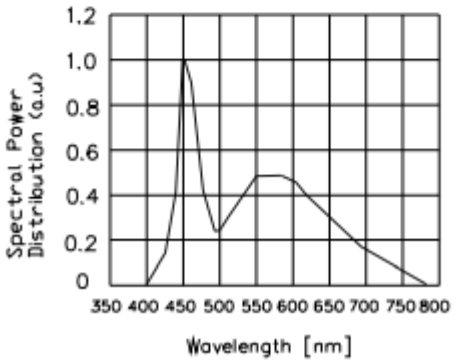


Fig 5. Spectral Power Distribution vs. Wavelength

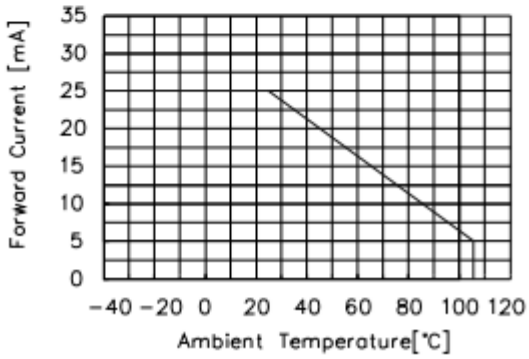
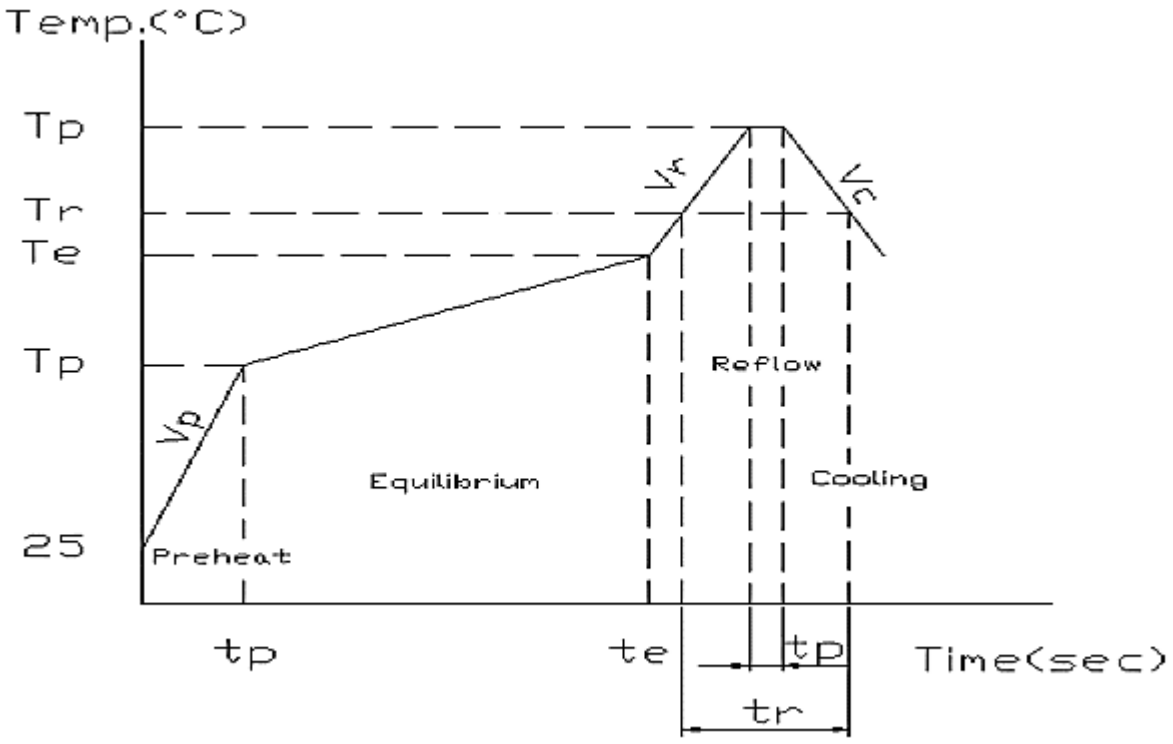


Fig 6. Forward current vs. Temperature

SOLDERING CHARACTERISTICS

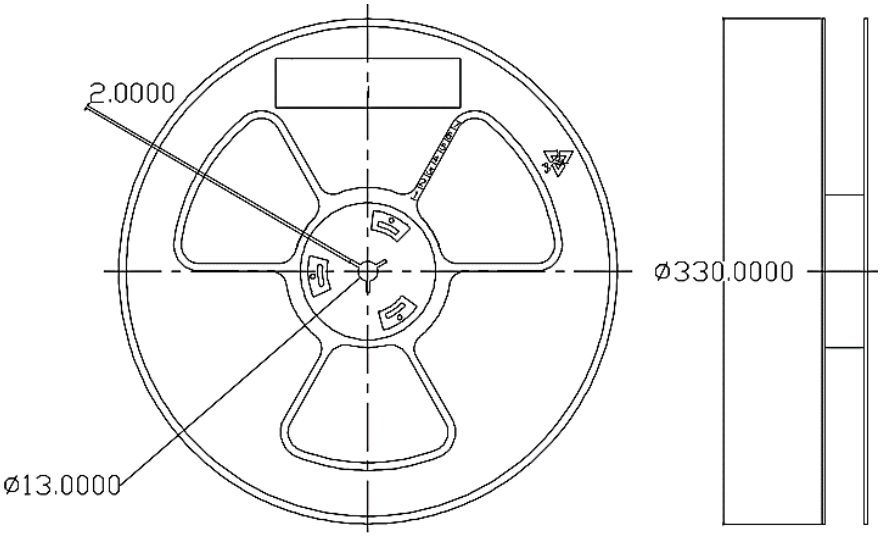
1. **IR-Reflow Soldering Profile**

Stage	Parameter	Symbol	Min.	Max.	Unit
Preheat	Ramp-up Rate	Vp	1	5	°C/sec
	Temperature	Tp	150	--	°C
	Time	tp	--	--	Sec
Equilibrium	Ramp-up Rate	Ve	--	--	°C/sec
	Temperature	Te	150	200	°C
	Time	te	60	120	Sec
Reflow	Ramp-up Rate	Vr	1	5	°C/sec
	Temperature	Tr	220	--	°C
	Time	tr	--	60	Sec
	Peak Temperature	Trp	--	260	°C
	Peak Time	trp	--	10	Sec
Cooling	Ramp-down Rate	Vc	3	6	°C/sec

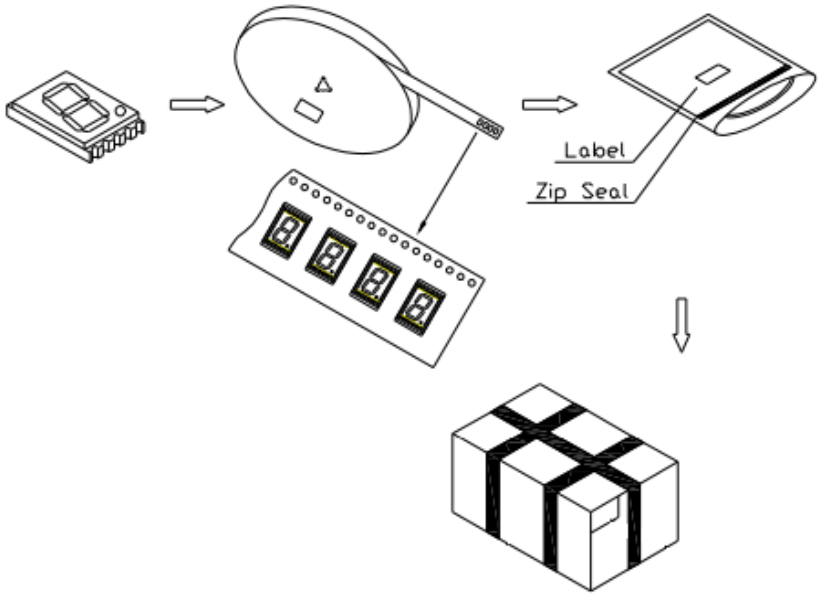


2. **Hand Soldering (Iron Condition)**
   1. Soldering Iron: 30W Max.
   2. Temperature: 350°C Max.
   3. Soldering Time: 3 seconds Max. (1 time)
   4. Distance: 1.6mm min.(from seating plane)

REEL DIMENSIONS



PACKING & LABEL DIMENSIONS



Package Name	Size	Unit	Amount	Unit	Amount	Unit	Note
Reel	Ø330	mm	1	Reel	1000	Pcs	/
Bag	L450*W430	mm	1	Reel	1000	Pcs	/
Outer Box	L430*W390*H300	mm	5	Bag	5000	Pcs	/

STORAGE METHOD

Storage Conditions

Before opening the package:

- The LEDs should be kept 30°C or less, RH 90% or less. The LEDs should be used within a year.
- When storing the LEDs, moisture proof packaging with absorbent material (silica gel) is recommended.

After opening the package:

- The LEDs should be kept at 30°C or less, 70%RH or less.
- The LEDs should be soldered within 168 hours (7 days) after opening the package.
- If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moistures absorbent material (silica gel).
- It is recommended to return the LEDs to the original moisture proof bag and to reseal the moisture proof bag again.
- If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking is required and should be performed under the following condition:
    - 65±5°C for more than 24 hours.